

ACE124201B P-Channel Enhancement Mode Power MOSFET

Description

- load switch
- battery protection

Features

- V_{DS} (V) =-20V,
- \bullet I_D = -50A
- $R_{DS(ON)}$ @ $V_{GS} = -4.5V$, TYP $4.3m\Omega$
- $R_{DS(ON)}$ @ $V_{GS} = -2.5V$, TYP $5.5m\Omega$

Absolute Maximum Ratings @T_A=25℃ unless otherwise noted

Parameter		Symbol	Max	Unit
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V_{GSS}	±12	V
Drain Current (Continuous)*C	T _C =25°C		-50	^
	T _C =100°C	I _D	-48	Α
Drain Current (Pulsed)*B		I _{DM}	-200	Α
Power Dissipation	T _C =25°C	P_D	52	W
Operating temperature / storage temperature		T _J /T _{STG}	-55~150	°C

Thermal Resistance Ratings

Parameter		Symbol	Maximum	Unit
Maximum Junction-to-Ambient*A	t ≤ 10s	R_{thJA}	33	°C/W
Maximum Junction- to-Case (Drain)	Steady State	R_{thJC}	2.4	C/VV

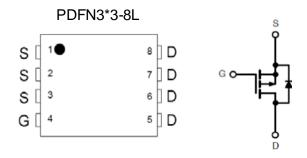
A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design.

- B: Repetitive rating, pulse width limited by junction temperature.
- C: The current rating is based on the t≤ 10s junction to ambient thermal resistance rating. Package Limited 50A.

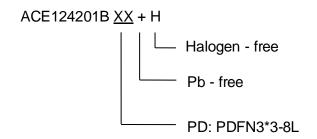


P-Channel Enhancement Mode Power MOSFET

Packaging Type



Ordering information





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Electrical Characteristics T_A=25°C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static*B							
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} =0V, I_D =-250 μ A	-20			V	
Zero gate voltage drain current	I_{DSS}	V _{DS} =-16V, V _{GS} =0V			-1	μΑ	
Gate threshold voltage	$V_{\text{GS(th)}}$	V_{GS} = V_{DS} , I_{DS} =-250 μ A	-0.4		-1	V	
Gate leakage current	I_{GSS}	$V_{GS}=\pm 12V$, $V_{DS}=0V$			±100	nA	
Drain-source on-state resistance	R _{DS(ON)}	V_{GS} =-4.5 V , I_{D} =-15 A		4.3	5.6	mΩ	
		V_{GS} =-2.5V, I_{D} =-10A		5.5	7.5		
Diode forward voltage	V_{SD}	I_{SD} =-10A, V_{GS} =0V			-1.2	V	
Diode Forward Current *A	Is	$T_C = 25^{\circ}C$			-43	Α	
Switching							
Total gate charge	Qg	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-10A		52		nC	
Gate-source charge	Qgs			8			
Gate-drain charge	Qgd			16			
Turn-on delay time	t _{d(on)}	V_{GS} =-10V, V_{DS} =-10V, R_{L} =1 Ω , R_{GEN} = 3 Ω		38			
Turn-on rise time	Tr			21		ns	
Turn-off delay time	$t_{\text{d(off)}}$			92			
Turn-off fall time	Tf			45			
		Dynamic					
Input capacitance	Ciss	V _{GS} =0V, V _{DS} =-10V, f=1MHz		3850			
Output capacitance	Coss			520		pF	
Reverse transfer capacitance	Crss	I= I IVI⊓∠		330			

A: The current rating is based on the t≤ 10s junction to ambient thermal resistance rating. Package Limited 50A.

B: Pulse Test: Pulse Wide≤ 300µs, Duty Cycle≤ 2%.



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Typical Performance Characteristics T_J = 25 °C, unless otherwise noted

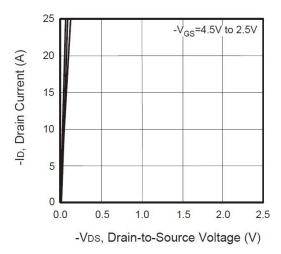


Figure 1. Output Characteristics

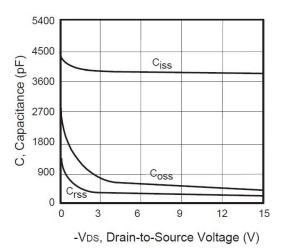


Figure 3. Capacitance

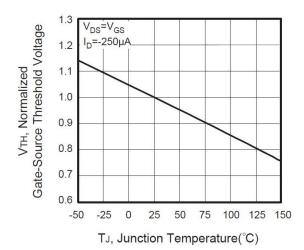


Figure 5. Gate Threshold Variation with Temperature

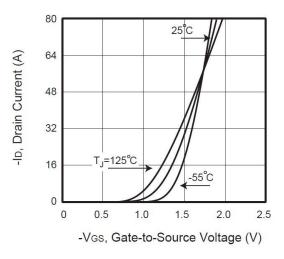


Figure 2. Transfer Characteristics

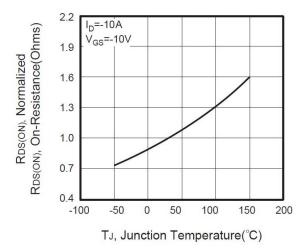


Figure 4. On-Resistance Variation with Temperature

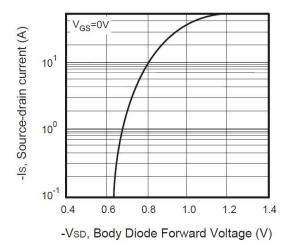


Figure 6. Body Diode Forward Voltage Variation with Source Current



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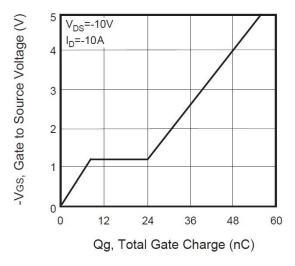


Figure 7. Gate Charge

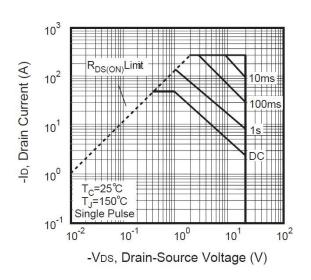


Figure 8. Maximum Safe Operating Area

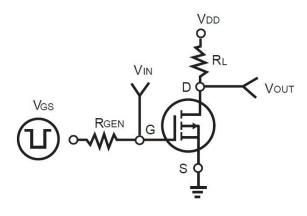


Figure 9. Switching Test Circuit

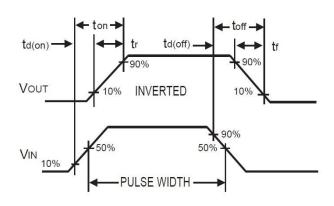


Figure 10. Switching Waveforms

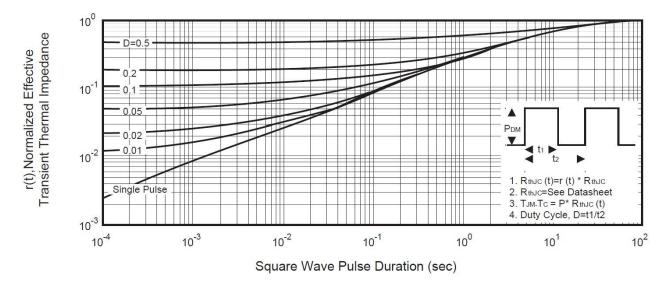


Figure 11. Normalized Thermal Transient Impedance Curve

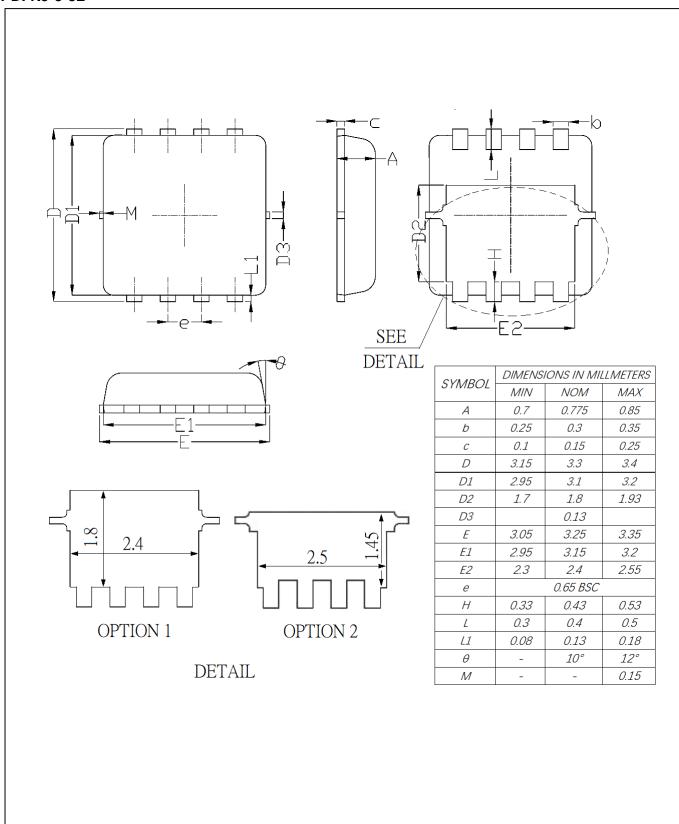
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Packing Information

PDFN3*3-8L



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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Technology Co., LTD. As sued herein:

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- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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